

## Statement of Compliance

#### **Requested Part**

08 June 2023	105807	(Part 1 of 1)	
	TE Internal Number:	1058077-1	
	Product Description:	3282 2223 00	
	Part Status:	Obsolete	
	Mil-Spec Certified:	No	
	EU RoHS Directive 2011/65/EU:	Compliant with Exemptions 6(c) - Pb-Alloy in Copper	

This declaration covers EU Directive 2011/65/EU incl. Delegated Directive 2015/863/EU.

EU ELV Directive: 2000/53/EC	Compliant with Exemptions 3 - Lead in copper alloy containing up to 4% lead by weight.
China RoHS 2 Directive: MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation: (EC) No. 1907/2006	Current ECHA Candidate List: <b>JAN 2023 (233)</b> Candidate List Declared Against: <b>JUL 2021 (219)</b> SVHC > Threshold: Pb (3.7% in Component Part) Article Safe Usage Statements:
	Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content:	Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability Code:	Not applicable for solder process capability

**TE** Connectivity Corporation

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This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change.

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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Restricted Materials Above Threshold

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### 中国电子电气产品中有害物质的名称及含量

#### China EEP Hazardous Substance Information

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8077-1	铅	· _				Hazardous Substance						
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	(Pb)	(Hg)	(Cd)	(Cr6)	(PBB)	(PBDE)						
器系统	х	0	0	0	0	0						
tor Systems)												
				r an nomogen								
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ndicates that the c	oncentration o	f the hazardou	is substance ir	n at least one l	homogeneous	material of the						
		old of the GB/T										
	表示该有害物质在i ndicates that the c elow the relevant 表示该有害物质至约	K器系统 tor Systems) K格依据SJ/T 11364标准的规定编 表示该有害物质在该部件所有均质 ndicates that the concentration or elow the relevant threshold of the 表示该有害物质至少在该部件的某	K器系统 tor Systems) K格依据SJ/T 11364标准的规定编制。 K示该有害物质在该部件所有均质材料中的含量 Indicates that the concentration of the hazardou elow the relevant threshold of the GB/T 26572 K示该有害物质至少在该部件的某一均质材料中	K器系统 X O O O Example 2 Content of the systems) Kak依据SJ/T 11364标准的规定编制。 This table is This	K器系统 X O O O O A Constraint of the second state of the second	K器系统 X O O O O O O O A Content of the hazardous substance in all homogeneous materials						

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